

Product Summary

V _{BR} (min)	I _{PP} (max)	C _T (typ)
26V	2A	6pF

Features and Benefits

- One Channel of ESD Protection
- Sidewall Plating for Easy Optical Inspection
- Low Profile and Ultra-small Form Factor Minimizes PCB Footprint
- Provides ESD Protection per IEC 61000-4-2 Standard:
Air ±20kV, Contact ±20kV
- Low Channel Input Capacitance to Prevent Data Degradation
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **The D24V0L1B2LPSQ is suitable for automotive applications requiring specific change control and is AEC-Q101 qualified, is PPAP capable, and is manufactured in IATF16949:2016 certified facilities.**

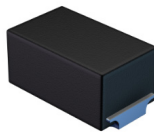
Description and Applications

The D24V0L1B2LPSQ is a next generation ESD and surge protection device packaged in a low-profile, small form factor package that features sidewall plating for easy optical inspection. It is qualified to AEC-Q101, supported by a PPAP, and is ideal for protecting one data line in:

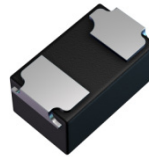
- Controller Area Networks (CAN)
- Local Interconnect Networks (LIN)
- FlexRay® Automotive Networks

Mechanical Data

- Case: U-DFN1006-2/SWP with Sidewall Plating
- Case Material: Molded Plastic, "Green" Molding Compound.
UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: 100% Sn (Tin)
Solderable per MIL-STD-202, Method 208 Ⓔ4
- Weight: 0.001 grams (Approximate)



Top View



Bottom View



Device Schematic

Ordering Information (Note 4)

Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
D24V0L1B2LPSQ-7B	Automotive	SG	7	8	10,000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information



SG = Product Type Marking Code

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P _{PP}	90	W	8/20μs, Per Figure 3
Peak Pulse Current	I _{PP}	2	A	8/20μs, Per Figure 3
ESD Protection – Contact Discharge	V _{ESD_Contact}	±20	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	V _{ESD_Air}	±20	kV	IEC 61000-4-2 Standard

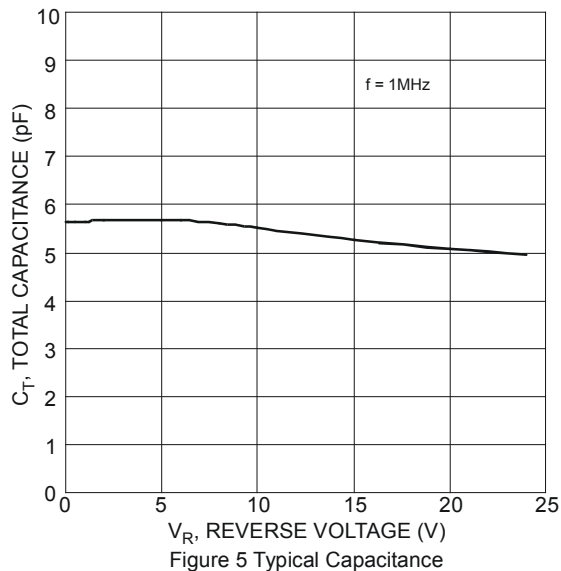
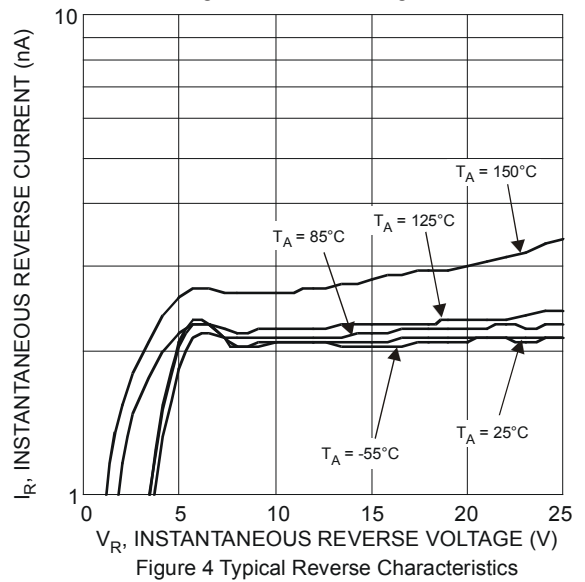
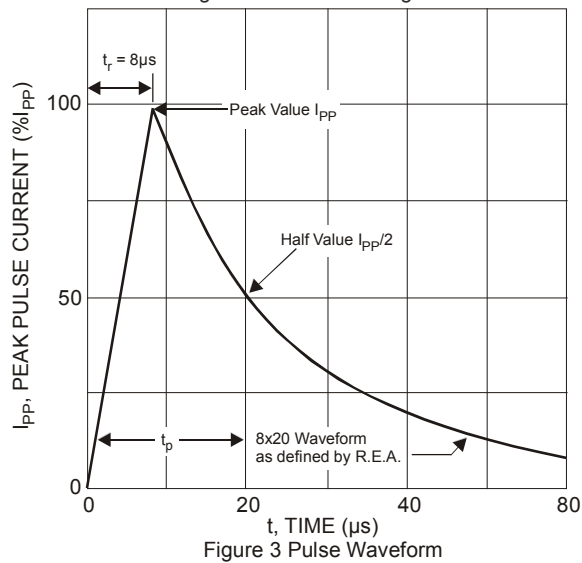
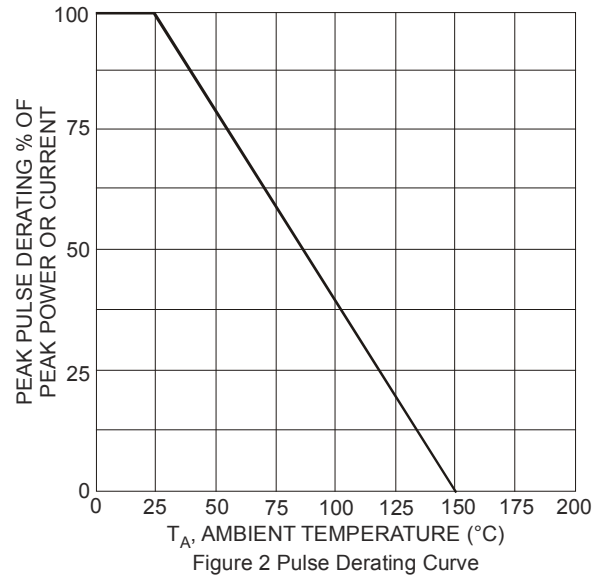
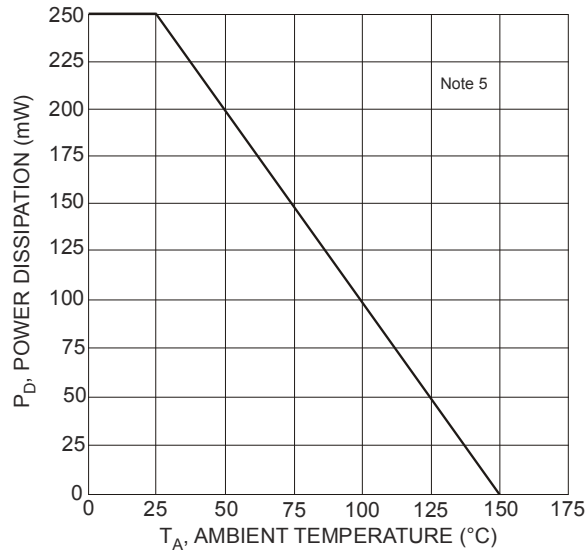
Thermal Characteristics

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P _D	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	R _{θJA}	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions
Reverse Standoff Voltage	V _{RWM}	—	—	24	V	—
Channel Leakage Current (Note 6)	I _{RM}	—	—	100	nA	V _{RWM} = 24V
Clamping Voltage, Positive Transients	V _{CL}	—	—	42	V	I _{PP} = 1A, t _p = 8/20μS
		—	—	46	V	I _{PP} = 2A, t _p = 8/20μS
Breakdown Voltage	V _{BR}	26	—	32	V	I _R = 1mA
Channel Input Capacitance	C _T	—	6	10	pF	V _R = 0V, f = 1MHz

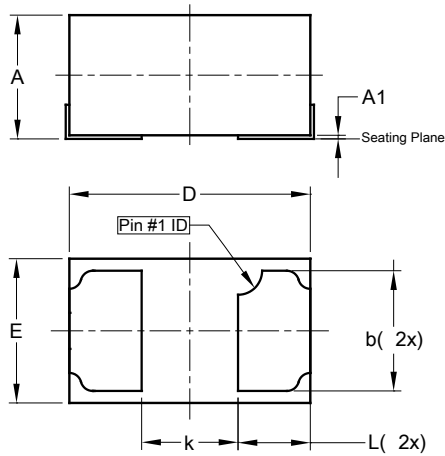
Notes: 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout, which can be found on our website at <http://www.diodes.com/package-outlines.html>.
6. Short duration pulse test used to minimize self-heating effect.



Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

U-DFN1006-2 (SWP)

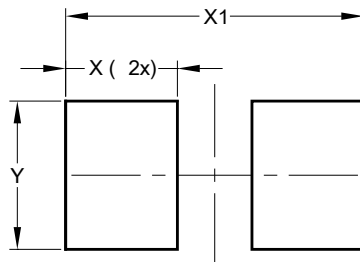


U-DFN1006-2/SWP			
Dim	Min	Max	Typ
A	0.47	0.53	0.50
A1	0.0	0.05	0.03
b	0.45	0.55	0.50
c	0.55 REF		
D	0.95	1.05	1.00
E	0.55	0.65	0.60
h	0.17 REF		
k	0.37 REF		
L	0.25	0.35	0.30
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

U-DFN1006-2 (SWP)



Dimensions	Value (in mm)
X	0.45
X1	1.20
Y	0.60

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